

**(T)EE2026**

**Digital Fundamentals**

**(L7: Logic IC families)**

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# Outline

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- Introduction to digital IC technologies
- Logic gate characteristics
- CMOS logic gates
- TTL logic gates
- Commercial logic families
- CMOS-TTL Interfacing

# Logic gate characteristics

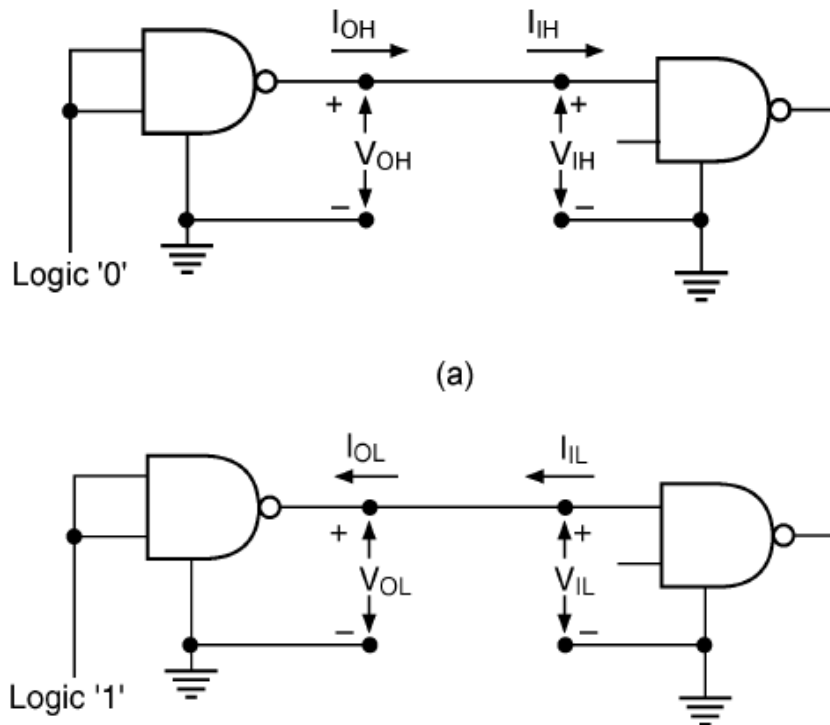
- **Static parameters**

- $V_{OL}$  → Maximum Logic LOW output voltage
- $V_{OH}$  → Minimum Logic HIGH output voltage
- $V_{IL}$  → Maximum Logic LOW input voltage
- $V_{IH}$  → Minimum Logic HIGH input voltage
- $NM_H$  → Noise margin high
- $NM_L$  → Noise margin low
- $I_{OL}/I_{OH}$  → Logic LOW/HIGH output currents
- $I_{IL}/I_{IH}$  → Logic LOW/HIGH input currents (for TTL only)
- Power dissipation

- **Dynamic parameters**

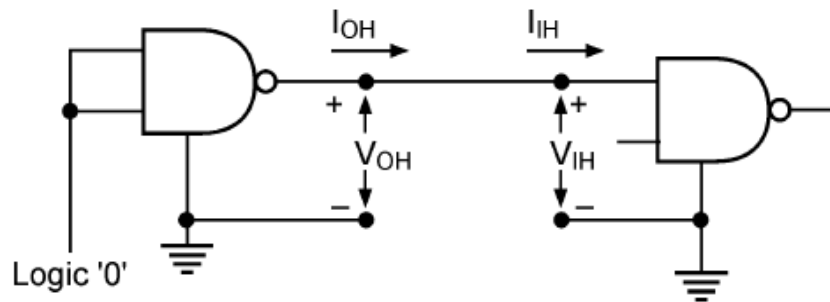
- Propagation delay
- Fan-out

# $V_{OH}$ , $V_{OL}$ , $V_{IH}$ , $V_{IL}$

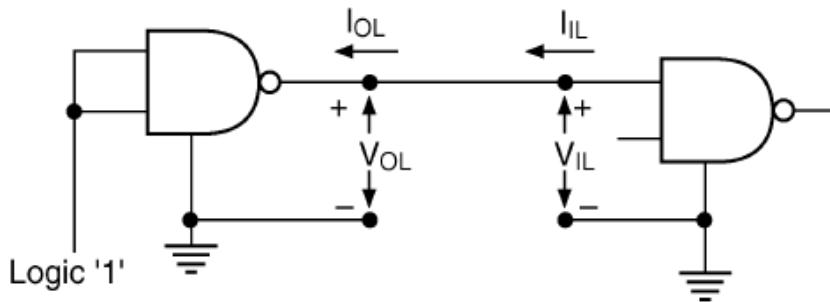


- $V_{OH}$  is minimum output voltage that establishes valid logic high to the following gate
- $V_{OL}$  is the maximum output voltage that established valid logic low to the following gate
- $V_{IH}$  is the minimum valid logic high input voltage
- $V_{IL}$  is the maximum valid logic low input voltage

# $I_{OH}$ , $I_{OL}$ , $I_{IH}$ , $I_{IL}$

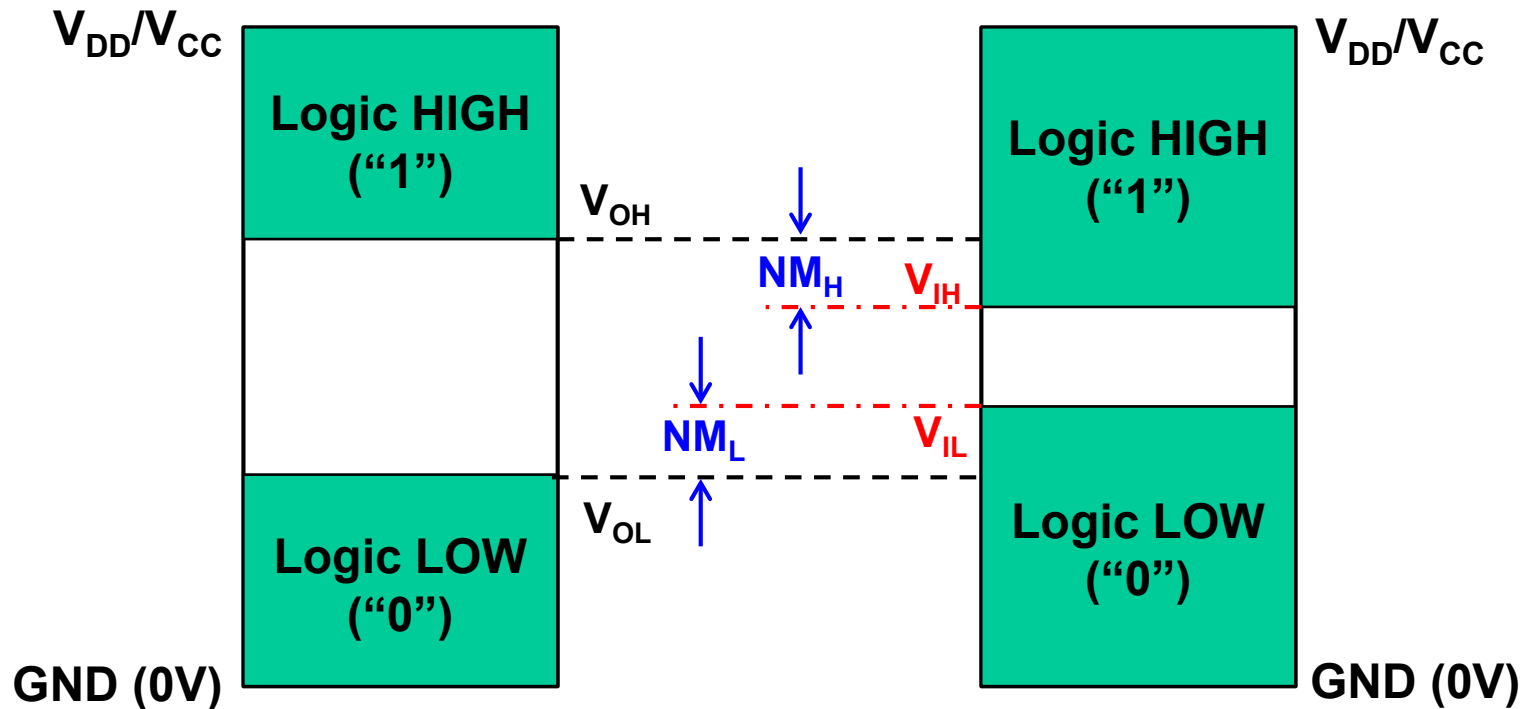


(a)



- $I_{OH}$  is maximum current that can flow out of an output when output voltage maintains a valid logic high
- $I_{OL}$  is the maximum current that can flow into an output when output voltage maintains a valid logic low
- $I_{IH}$  is the current flowing into or out of an input when the input voltage is a valid logic high
- $I_{IL}$  is the current flowing into or output an input when the input voltage is a valid logic low

# Noise margin ( $NM_H$ , $NM_L$ )



$$NM_H = V_{OH} - V_{IH}$$

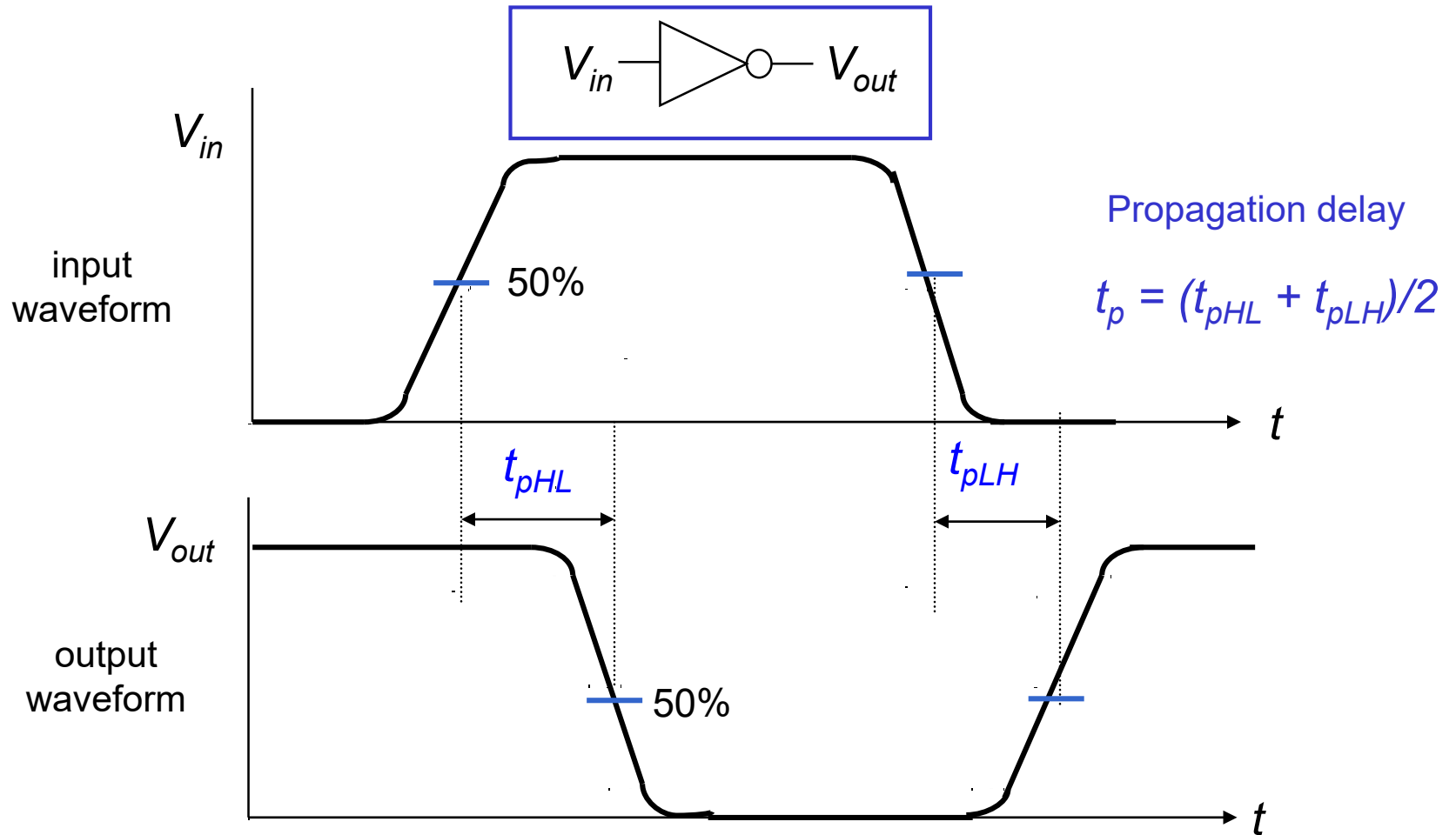
$$NM_L = V_{IL} - V_{OL}$$

# Power Dissipation

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- Represents the amount of power **needed by the gate**. Often expressed in mW (milliwatts).
- Calculated from the supply voltage  $V_{CC}$  and the current  $I_{CC}$  that is drawn by the circuit.
- Power dissipation  $P_D = V_{CC} * I_{CC}$
- Current drawn depends on the logic state of gate.

# Propagation delay





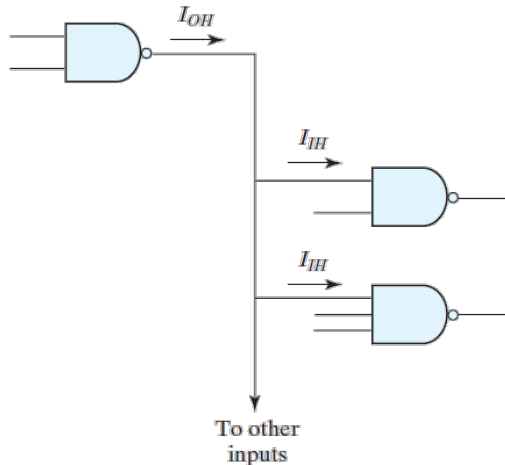
# Fan-Out

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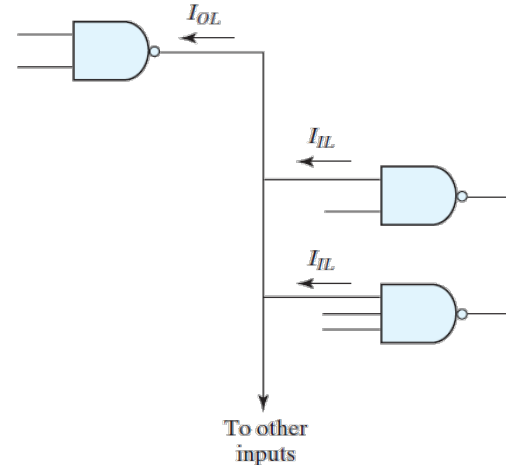
- Determines how many standard loads can be connected to the output of a gate
  - A standard load is defined as the amount of current needed by an input of another gate in the same logic family
  - **Loading** is also used to indicate fan-out.
- The output of a gate can supply a limited amount of current. Above that it is said to be **overloaded**.
- Each input of a gate also requires current
- Each additional connection adds to the gate load
- Exceeding the maximum load may cause malfunction

# Fan-Out

## Output is logic HIGH:



## Output is logic LOW:



- Calculated from the amount of current **available in the gate-output** to that is **needed in the input**.
- Fan-out =  $\min(I_{OH}/I_{IH}, I_{OL}/I_{IL})$
- Example: standard TTL gates  
 $I_{OH} = 400 \mu A$ ,  $I_{IH} = 40 \mu A$ ,  $I_{OL} = 16 \text{ mA}$ ,  $I_{IL} = 1.6 \text{ mA}$ 
  - Fan-out =  $\min(400/40, 16/1.6) = 10$
  - The maximum number of gates that can be connected (or driven) is 10

# Digital IC technologies

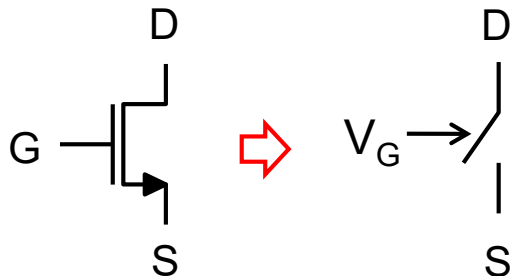
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- Digital integrated circuits can be designed in different technologies
- Technology will impact on the performance of ICs
- The two mainstream technologies are
  - CMOS IC technology
  - Bipolar IC technology
- CMOS IC technology is based metal-oxide-semiconductor field-effect transistors (MOSFET)
- Bipolar IC technology is based on bipolar junction transistors (BJT)

# Transistor as a switch

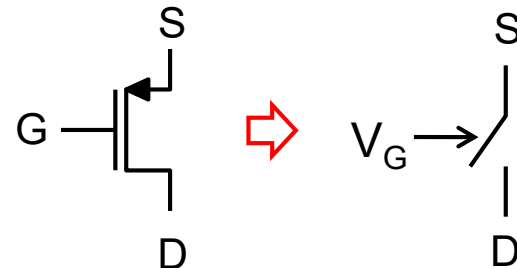
- In this part, we consider an MOS transistor (MOSFET) as a switch
- MOS transistors can be either NMOS or PMOS transistors
- We view a 3-terminal MOSFET as a blackbox whose drain and source terminals are equivalent to the two terminals of an ordinary switch and the gate controls the switch

## NMOS transistor:



$V_G = V_{DD}$  ("1")  $\rightarrow$  NMOS is **on** (switch closed)  
 $V_G = 0V$  ("0")  $\rightarrow$  NMOS is **off** (switch open)

## PMOS transistor:



$V_G = 0V$  ("0")  $\rightarrow$  PMOS is **on** (switch closed)  
 $V_G = V_{DD}$  ("1")  $\rightarrow$  PMOS is **off** (switch open)

# Logic ICs based on BJT IC technology

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- **TTL** (Transistor-Transistor Logic)
  - Invented by TRW Inc. in US, first commercial TTL logic IC was introduced by Sylvania in 1963 and became popular with Texas Instrument's 5400 and 7400 series
- **ECL** (Emitter-Coupled Logic)
  - Invented by IBM, first commercial integrated-circuit ECL family was introduced by Motorola in 1962
  - Suitable for high-speed logic circuits

# TTL logic gates

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## Features of TTL logic gates

- Based on BJTs
- Most widely used logic ICs at gate or MSI level
- Typically operated under 5V supply voltage
- Having different series that optimized for low power, high speed, etc
- Inputs of the gate draw static current
- Due to lack of prerequisite, we will not discuss circuit details of logic gates (look forward to seeing you attending EE4415 module)

# CMOS/TTL Comparison (static)

Input/output voltage levels (in volts) with  $V_{DD} = V_{CC} = +5\text{ V}$ .

Parameter	CMOS							TTL			
	4000B	74HC	74HCT	74AC	74ACT	74AHC	74AHCT	74	74LS	74AS	74ALS
$V_{IH}$ ( <i>min</i> )	3.5	3.5	2.0	3.5	2.0	3.85	2.0	2.0	2.0	2.0	2.0
$V_{IL}$ ( <i>max</i> )	1.5	1.0	0.8	1.5	0.8	1.65	0.8	0.8	0.8	0.8	0.8
$V_{OH}$ ( <i>min</i> )	4.95	4.9	4.9	4.9	4.9	4.4	3.15	2.4	2.7	2.7	2.7
$V_{OL}$ ( <i>max</i> )	0.05	0.1	0.1	0.1	0.1	0.44	0.1	0.4	0.5	0.5	0.4
$V_{NH}$	1.45	1.4	2.9	1.4	2.9	0.55	1.15	0.4	0.7	0.7	0.7
$V_{NL}$	1.45	0.9	0.7	1.4	0.7	1.21	0.7	0.4	0.3	0.3	0.4

Noise margin H and L

# Summary

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- Digital IC technology
  - BJT and MOSFET
  - BJT and CMOS technology
- CMOS logic gates
  - Implementation of NOT, NAND, NOR, AND and OR gates
- Commercial logic families
  - TTL and CMOS
- Logic gate characteristics
  - Static parameters ( $V_{OH}$ ,  $V_{OL}$ ,  $V_{IH}$ ,  $V_{IL}$ ,  $I_{OH}$ ,  $I_{OL}$ ,  $I_{IH}$ ,  $I_{IL}$ ,  $NM_H$ ,  $NM_L$  and  $P_D$ )
  - Dynamic parameters ( $t_p$  and fan-out)
  - CMOS/TTL comparison
- Logic family interfacing (TTL driving CMOS, CMOS driving TTL)



# To keep in mind, overall...

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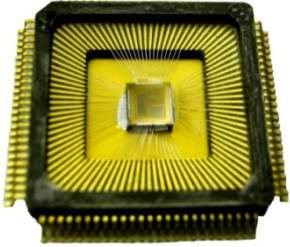
**MOTIVATION: WHY ARE WE  
DOING THIS?**

**IMPACT: WHAT CAN YOU DO  
WITH YOUR KNOWLEDGE?**

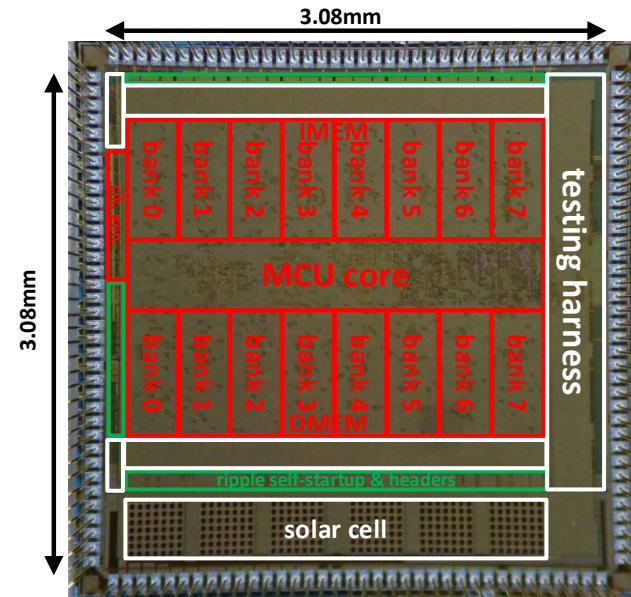
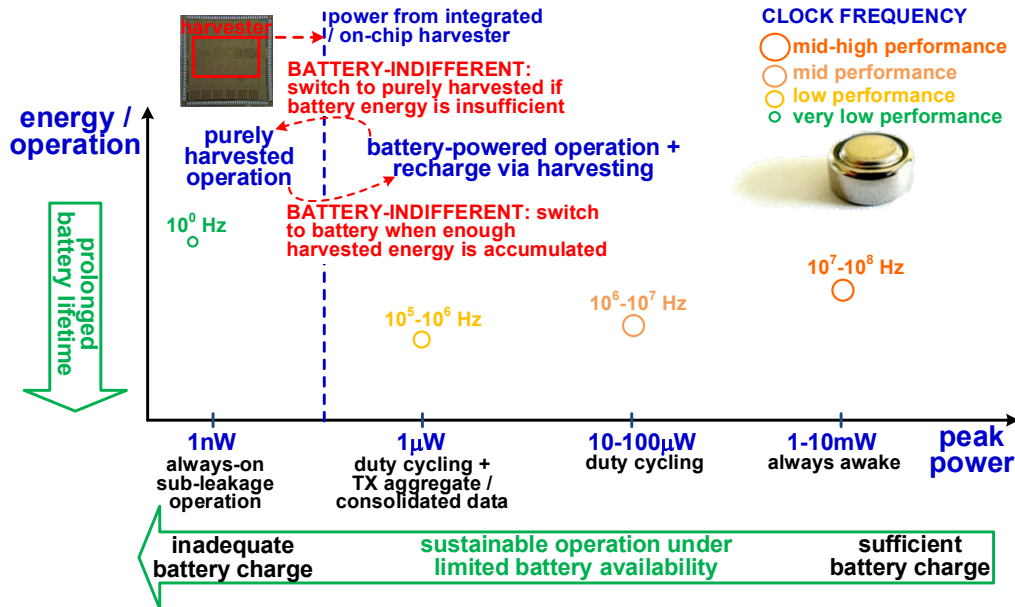
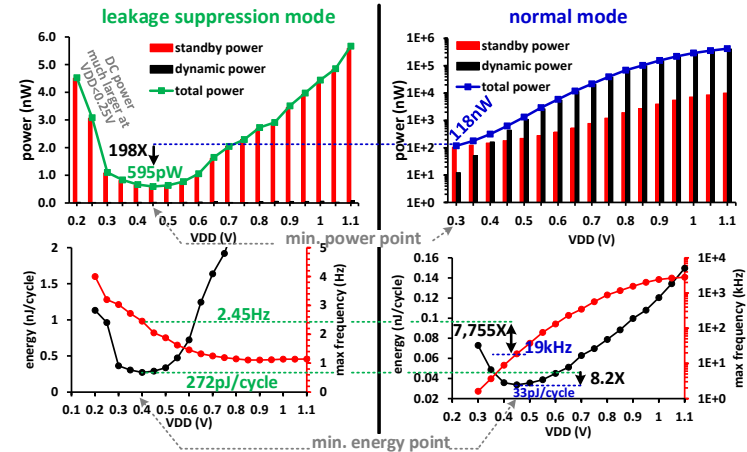
*Massive*



# What You Will Be Able to Do in a Few Weeks...

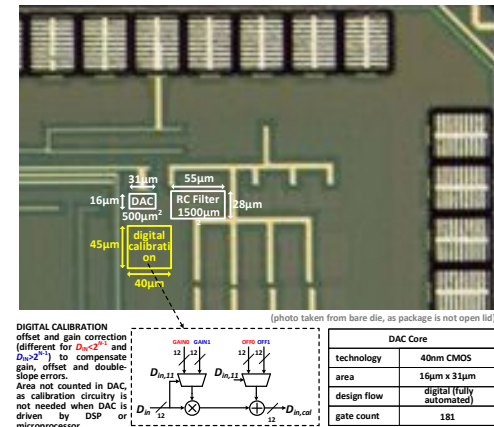
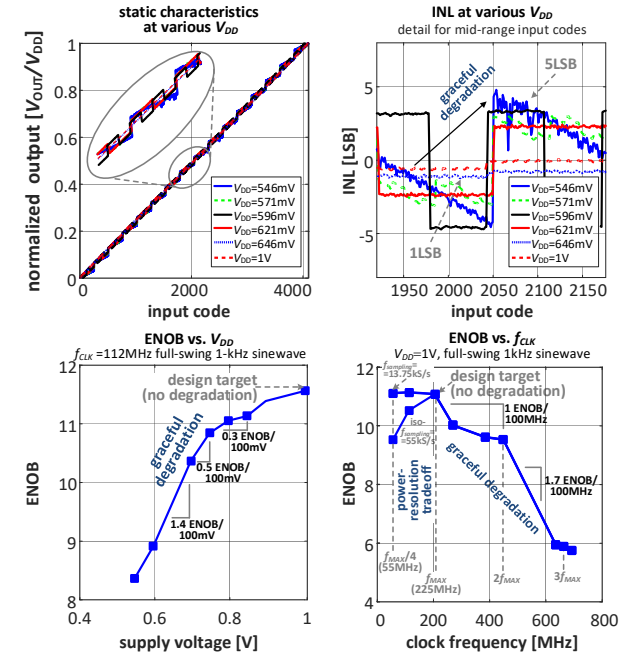
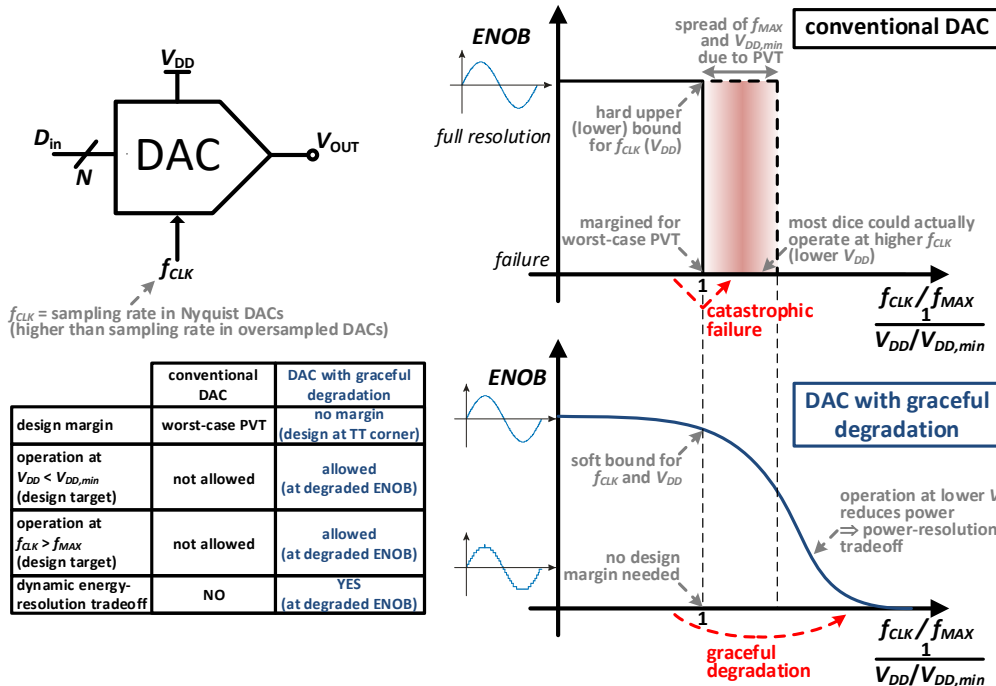


# What You Will Be Able to Do in a Few Years...





# What You Will Be Able to Do in a Few Years...



# What You Will Be Able to Do in a Few Years...



Comparison table and summary (best performance in bold)

specification	[3]	[4]	This work
process	90nm	32nm	28nm
area ( $F^2$ , with $F=\min.$ feature size)	$247 \cdot 10^6$	<b><math>43 \cdot 10^6</math> *</b>	$167 \cdot 10^6$
EQ scalable	NO	NO	<b>YES</b>
ADC on chip	NO (fully analog)	NO	<b>YES</b>
sampling rate (kS/s)	N.A.	16	8
interval between decisions (ms)	< 100	10	<b>8†</b>
energy (nJ/frame)	600 (10.6X)	500* (8.9X)*	<b>56.5 - 182.4</b> (1 - 3.2X)
VAD			
accuracy	87% ‡	97%	85.8% - 87.6%
classification quality	F-measure ‡	N.A. §	83.4%
SNR in adopted benchmark (dB)	12	N.A. §	10

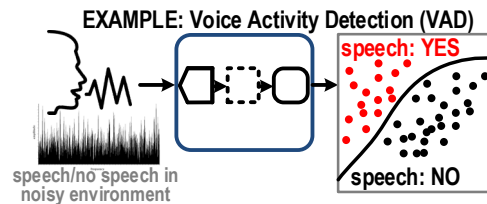
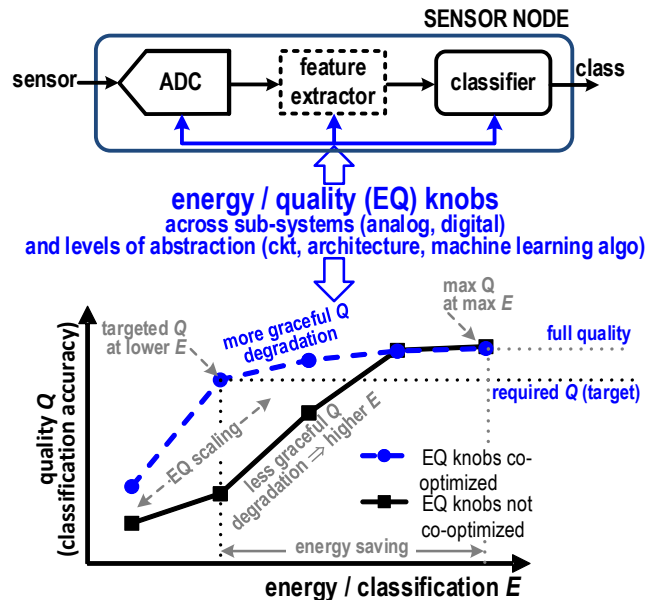
\* analog interface is not included

† shorter interval between decisions means finer temporal granularity in classification, increasing the opportunities to save energy in the subsequent blocks (e.g., speech recognition)

‡ assuming 50% true positives and 50% true negatives

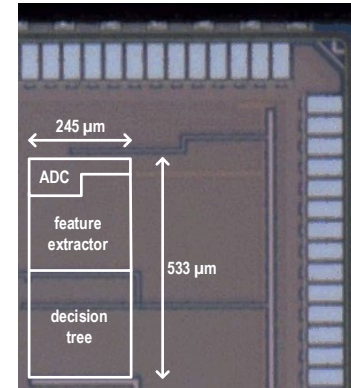
§ no information on benchmark is available

|| at OSR=512



## LOWER QUALITY OFTEN ACCEPTABLE

level	example
APPLICATION	automated light control in the presence of speech needs lower accuracy than security
CONTEXT	lower accuracy is enough if uninterrupted speech was detected for a long period
DATASET	highest quality is not useful in noisy environment (max accuracy is degraded anyway)



ADC	voltage	1 V
	frequency	< 4.1 MHz (oversampling clock)
	frequency	8 kHz (downsampling clock)
FE	area	0.015 mm <sup>2</sup>
	integrator RC time constant	40 $\mu\text{s}$
	frequency	8 kHz
	architecture	64-pt SDF radix-2
	bit width	23 bits
DT	frequency	512 kHz
	voltage	0.5 V
	area	0.046 mm <sup>2</sup>
overall	voltage	0.5 V
	frequency	8 kHz
	area	0.069 mm <sup>2</sup>
	memory size	10.5 kb
overall	area	0.13 mm <sup>2</sup>
	power	7.06 - 22.8 $\mu\text{W}$

# What You Will Be Able to Do in a Few Weeks...


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**The limit is our imagination and creativity...**


**Unleash them (please)**

# Let Us Play a Bit...

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# Commercial logic families

- 74xxx Series
  - **TTL** family (**T**ransistor-**T**ransistor **L**ogic)
  - Use Bipolar or CMOS technology
- Name convention
  - 1<sup>st</sup> field: 2 or 3 letters → Manufacturer (sometimes omitted)
  - 2<sup>nd</sup> field: 74 → Commercial temperature range (54 → Military)
  - 3<sup>rd</sup> field: 4 letters → Logic sub-family
  - 4<sup>th</sup> field: 2 or more digits → Type of device
  - 5<sup>th</sup> field: Type of package or other information (sometimes omitted)

<u>DM</u>	<u>74</u>	<u>LS</u>	<u>14</u>	<u>N</u>
↓	↓	↓	↓	↓
National Semiconductor	Commercial temperature range	Low power shottky	Hex inverters with schmitt trigger inputs	Plastic package

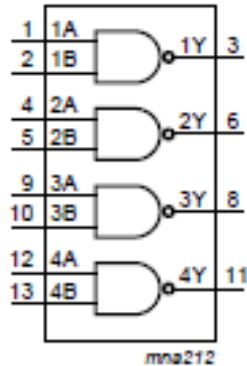
# 74 series Logic Sub-families (3<sup>rd</sup> field)

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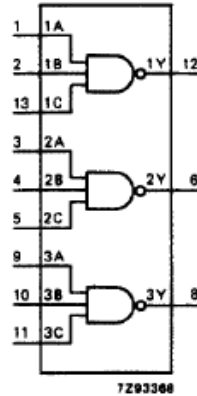
- TTL (Bipolar)
  - 74L → Low power
  - 74H → High speed
  - 74LS → Low power Schottky
  - 74AS → Advanced low power schottky
  - 74ALS → Advanced low power schottky
  - .....
- CMOS (not TTL, but retains some compatibility)  
(same part numbers as bipolar are retained to identify the function)
  - 74C → CMOS 4-15V
  - 74HC → High speed
  - 74AC → Advanced CMOS
  - 74LVC → Low voltage, 1.65 to 3.3V
  - 74LVX → 3.3V with 5V tolerant inputs
  - .....

# Some 74 series Logic gates

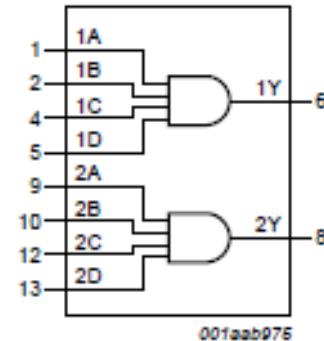
7400 (74HC00)  
(Quad 2-input NAND gate)



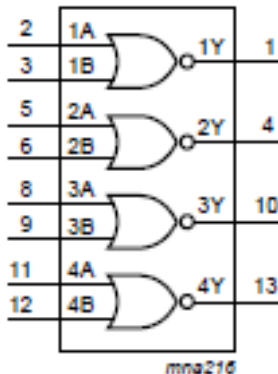
7410(74HC10)  
(Dual 3-input AND gate)



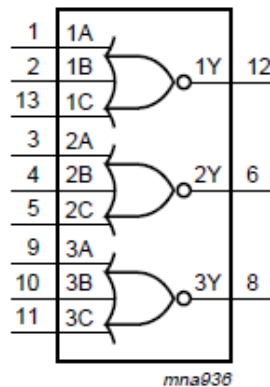
7421(74HC21)  
(Dual 4-input AND gate)



7402(74HC02)  
(Quad 2-input NOR gate)



7427(74HC27)  
(Quad 3-input NOR gate)



7404(74HC04)  
(Hex inverters)

